TECHNICAL DATA SHEET

BONDAN SE06

Revision: 19.03.2021 Version: 1.002



PRODUCT DESCRIPTION

BONDAN SE05 is a low viscous, very fast-curing adhesive. It is temperature-resistant up to approx. 80 °C and is suitable for bonding various materials such as many kinds of plastics, metals or wood.

TECHNICAL PROPERTIES

Appearance liquid

Color transparent

Chemical basis ethyl cyanoacrylate Viscosity at 25 °C $12-22 \text{ mPa} \cdot \text{s}$ Density at 25 °C $\approx 1.06 \text{ g/cm}^3$

Tensile strength (ASTM D412)

Neoprene $5-15 \text{ N/mm}^2$ Nitrile rubber $5-15 \text{ N/mm}^2$ EPDM $2-6 \text{ N/mm}^2$

Lap shear strength (ISO 4587)

Steel $15-25 \text{ N/mm}^2$ Aluminium $7-10 \text{ N/mm}^2$ ABS $6-10 \text{ N/mm}^2$ Polycarbonate (PC) $5-10 \text{ N/mm}^2$ Nitrile rubber $5-10 \text{ N/mm}^2$

(referring to ISO 4587)

Curing time in seconds at 22 ° C and 50% relative humidity (time until a tensile strength of 0.1 N/mm² is reached):

Plastics					Wood	Metals	
EPDM	Neoprene	Nitrile rubber	ABS	PC	Balsa	Steel	Aluminium
< 5	< 5	< 4	10 - 15	10 - 30	< 2	25 - 40	20 - 30

The curing time is particularly influenced by the relative humidity, material pairing, temperature, gap and substrate surface. In the case of materials that are difficult to bond, such as PE, PP, silicone, etc., we recommend pretreating the substrate with our primer BONDAN PR77.



TECHNICAL DATA SHEET

BONDAN SE06

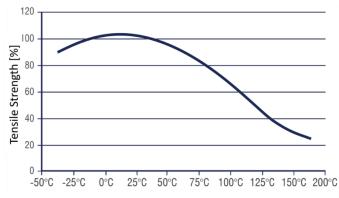
Revision: 19.03.2021 Version: 1.002



TENSILE STRENGTH

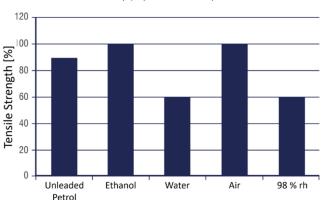
Temperature Resistance

Tested on steel, cured for 24 h and conditioned to test temperature for 1 h prior to testing.



Chemical Resistance

Exposure to the described conditions for 1000 h at 22 $^{\circ}$ C, except for 98 % relative humidity (rh) which was exposed at 42 $^{\circ}$ C.



DIRECTIONS FOR USE

- Please consult the safety data sheet before use.
- Clean, dry and grease-free surfaces ensure the maximum strength.
- Soiled surfaces must be cleaned (e.g. with BONDAN Cleaner or an appropriate solvent).
- Ensure sufficient flash-off time when cleaning parts.
- The curing time is especially influenced by the relative humidity, curing temperature, gap, substrate surface and material pairing.
- Dismantling and removal of adhesive residues can be facilitated by heating to 250 °C.

STORAGE

- 12 months at 2 to 10 °C in unopened packaging
- Do not store above 25 °C
- Store opened packaging in the refrigerator at 2 to 10 °C

PRODUCT LABELLING

See safety data sheet.

PACKAGE UNITS

For manual application

20 g, 50 g, 500 g

TECHNICAL DATA SHEET BONDAN SE06

Revision: 19.03.2021 Version: 1.002



All information provided is based on our extensive tests and practical experience. The data are given for information only. Drei Bond cannot assume responsibility for the results obtained by others which methods are not under our control. It is user's responsibility to determine suitability for user's purpose of any product mentioned herein. Drei Bond disclaims all warranties expressed or implied, including warranties of fitness for a particular purpose, arising from sale or use of BONDAN products.